## **Power MOSFET** 30 V, 12.5 A, N-Channel, SO-8

#### Features

- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### Applications

- DC-DC Converters
- Points of Loads
- Power Load Switch
- Motor Controls

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise stated)

Param	Symbol	Value	Unit		
Drain-to-Source Voltage			V <sub>DSS</sub>	30	V
Gate-to-Source Voltage	Gate-to-Source Voltage			±20	V
Continuous Drain	Steady	T <sub>A</sub> = 25°C	۱ <sub>D</sub>	10.3	А
Current $R_{\theta JA}$ (Note 1)	State	$T_A = 70^{\circ}C$		8.3	
Power Dissipation $R_{\theta JA}$ (Note 1)	Steady State	$T_A = 25^{\circ}C$	P <sub>D</sub>	1.35	W
Continuous Drain	Steady	T <sub>A</sub> = 25°C	I <sub>D</sub>	8.0	А
Current R <sub>0JA</sub> (Note 2)	State	$T_A = 70^{\circ}C$		6.4	
Power Dissipation $R_{\theta JA}$ (Note 2)		$T_A = 25^{\circ}C$	PD	0.8	W
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	۱ <sub>D</sub>	12.5	А
Current $R_{\theta JA}$ , t $\leq$ 10 s (Note 1)	Sidle	T <sub>A</sub> = 70°C		10	
Power Dissipation $R_{\theta JA}$ , t $\leq$ 10 s(Note 1)	Steady State	T <sub>A</sub> = 25°C	PD	2.0	W
Pulsed Drain Current	T <sub>A</sub> = 25°0	C, t <sub>p</sub> = 10 μs	I <sub>DM</sub>	100	А
Operating Junction and Storage Temperature			Т <sub>Ј</sub> , T <sub>stg</sub>	–55 to 150	°C
Source Current (Body Diode)			۱ <sub>S</sub>	2.0	А
Single Pulse Drain-to-Source Avalanche Energy (T <sub>J</sub> = 25°C, V <sub>DD</sub> = 30 V, V <sub>GS</sub> = 10 V, I <sub>L</sub> = 11 A <sub>pk</sub> , L = 1.0 mH, R <sub>G</sub> = 25 $\Omega$ )			E <sub>AS</sub>	60.5	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	92.7	°C/W
Junction-to-Ambient $-t \le 10 \text{ s}$ (Note 1)	$R_{\theta JA}$	61.7	
Junction-to-Foot (Drain)	$R_{\theta JF}$	23.5	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	155.6	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

 Surfacemounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).

2. Surfacemounted on FR4 board using the minimum recommended pad size.

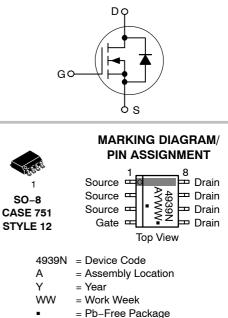


## **ON Semiconductor®**

#### http://onsemi.com

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX	
30 V	8.4 m $\Omega$ @ 10 V	12.5 A	
30 V	11 mΩ @ 4.5 V	12.5 A	





(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NTMS4939NR2G	SO-8 (Pb-Free)	2500/Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

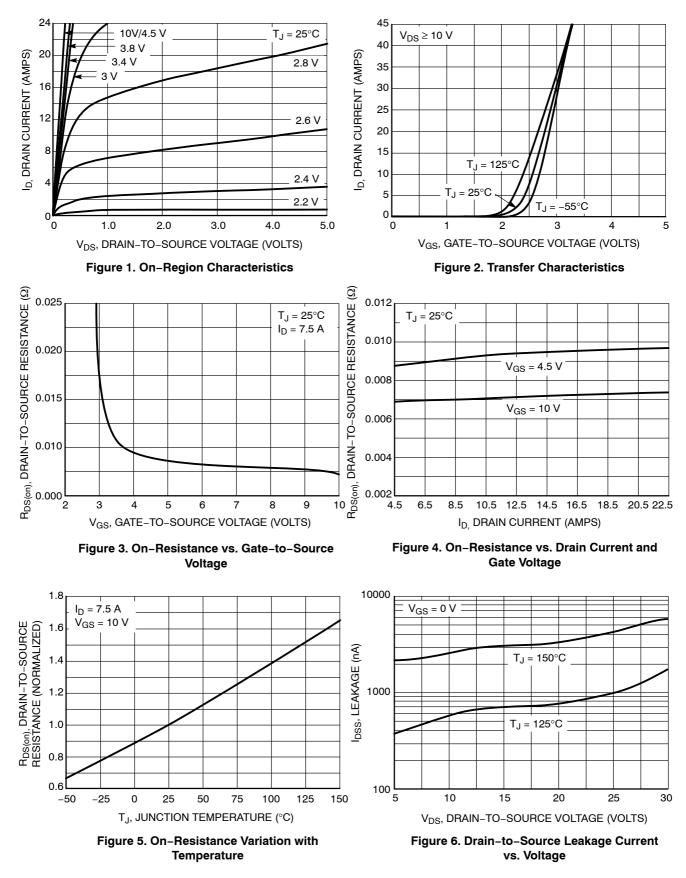


### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

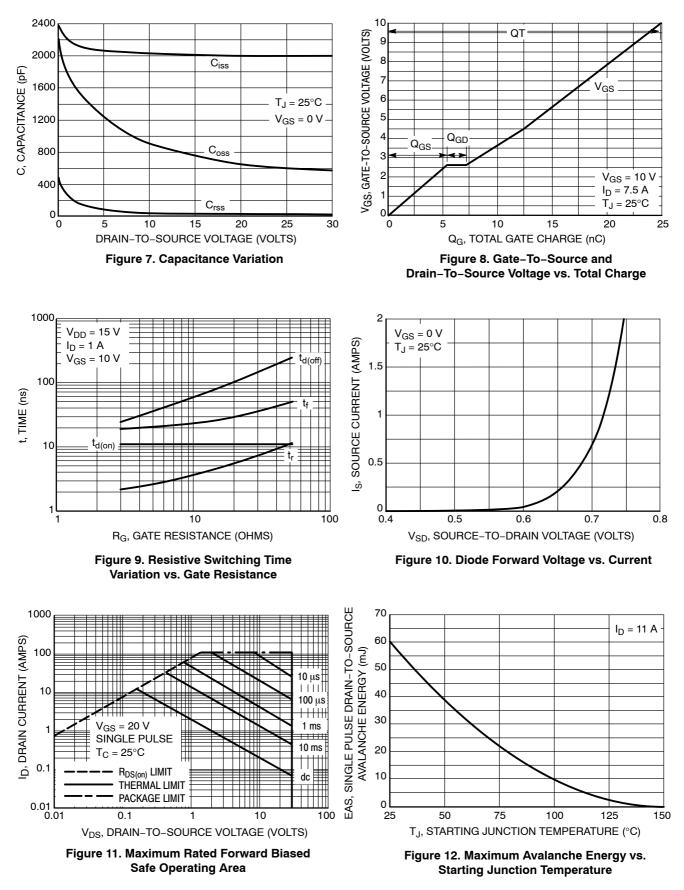
Parameter	Symbol	Test Condition		Min	Тур	Мах	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>				13.8		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		$T_J = 25^{\circ}C$			1.0	μΑ
		$V_{GS}$ = 0 V, $V_{DS}$ = 24 V	T <sub>J</sub> = 125°C			10	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ =	±20 V			±100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D = 2$	250 μΑ	1.0		2.5	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				5.0		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> =	7.5 A		7.0	8.4	mΩ
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> =	6.5 A		9.0	11	
Forward Transconductance	9FS	V <sub>DS</sub> = 1.5 V, I <sub>D</sub> =	7.5 A		23.8		S
CHARGES, CAPACITANCES AND G	ATE RESISTAN	ICE	-		-	-	-
Input Capacitance	C <sub>iss</sub>				2000		pF
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, f = 1.0 MHz,	V <sub>DS</sub> = 25 V		620		
Reverse Transfer Capacitance	C <sub>rss</sub>				16		
Total Gate Charge	Q <sub>G(TOT)</sub>				12.4		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>				3.3		
Gate-to-Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 15	V, I <sub>D</sub> = 7.5 A		5.3		
Gate-to-Drain Charge	Q <sub>GD</sub>				1.85		
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 15 V	/, I <sub>D</sub> = 7.5 A		25		nC
SWITCHING CHARACTERISTICS (No	ote 4)						
Turn-On Delay Time	t <sub>d(on)</sub>				10.6		ns
Rise Time	t <sub>r</sub>	Voc = 10 V Voc =	- 15 V		3.1		
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS} = 10 \text{ V}, \text{ V}_{DS} = $ $I_D = 1.0 \text{ A}, \text{ R}_G = $	6.0 Ω		36.7		
Fall Time	t <sub>f</sub>				21.5		
DRAIN-SOURCE DIODE CHARACTE	RISTICS					<b>.</b>	
Forward Diode Voltage	V <sub>SD</sub>		$T_J = 25^{\circ}C$		0.73	1.0	V
		$V_{GS}$ = 0 V, I <sub>S</sub> = 2.0 A	T <sub>J</sub> = 125°C		0.57		
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, d <sub>IS</sub> /d <sub>t</sub> = 100 A/μs, I <sub>S</sub> = 2.0 A			36.3		ns
Charge Time	t <sub>a</sub>				17.8		
Discharge Time	t <sub>b</sub>				18.5		
Reverse Recovery Charge	Q <sub>RR</sub>				32		nC
PACKAGE PARASITIC VALUES						1	1
Source Inductance	L <sub>S</sub>	T <sub>A</sub> = 25°C			0.66		nH
Drain Inductance	L <sub>D</sub>				0.2		1
Gate Inductance	L <sub>G</sub>				1.5		1
Gate Resistance	R <sub>G</sub>				0.4	1.0	Ω

Pulse Test: pulse width = 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

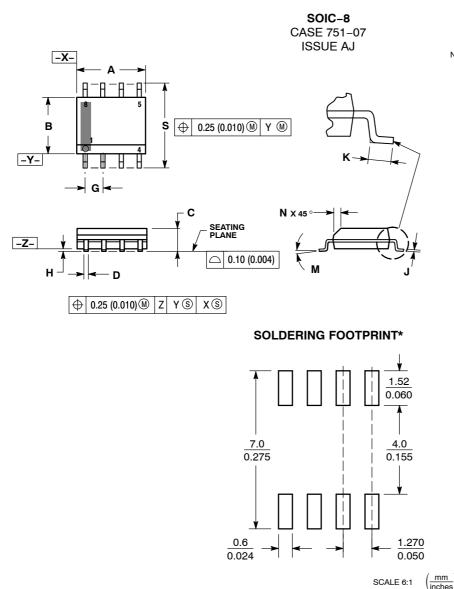




#### **TYPICAL PERFORMANCE CURVES**



#### PACKAGE DIMENSIONS



NOTES

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION. 2 З.
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) 4. PER SIDE
- DIMENSION D DOES NOT INCLUDE DAMBAR 5. PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT
- MAXIMUM MATERIAL CONDITION. 751-01 THRU 751-06 ARE OBSOLETE. NEW 6.
- STANDARD IS 751-07.

	MILLIMETERS		INC	NCHES		
DIM	MIN	MAX	MIN	MAX		
Α	4.80	5.00	0.189	0.197		
В	3.80	4.00	0.150	0.157		
С	1.35	1.75	0.053	0.069		
D	0.33	0.51	0.013	0.020		
G	1.27	1.27 BSC		0 BSC		
н	0.10	0.25	0.004	0.010		
J	0.19	0.25	0.007	0.010		
Κ	0.40	1.27	0.016	0.050		
М	0 °	8 °	0 °	8 °		
Ν	0.25	0.50	0.010	0.020		
s	5.80	6.20	0.228	0.244		

STYLE 12: PIN 1. SOURCE 2. SOURCE з. SOURCE 4. GATE 5 DRAIN DRAIN 6. 7. DRAIN

8. DRAIN

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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